

2SK3162

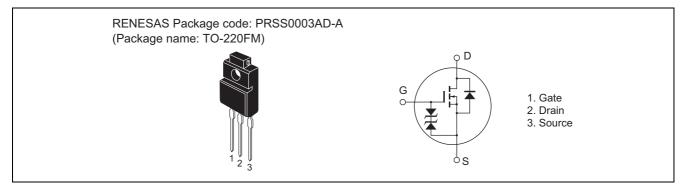
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1087-0400 (Previous: ADE-208-735C) Rev.4.00 Sep 07, 2005

Features

- Low on-resistance $R_{DS} = 60 \text{ m}\Omega \text{ typ.}$
- High speed switching
- 4 V gate drive device can be driven from 5 V source

Outline





Absolute Maximum Ratings

| | | | $(Ta = 25^{\circ}C)$ |
|--|----------------------------------|-------------|----------------------|
| Item | Symbol | Ratings | Unit |
| Drain to source voltage | V _{DSS} | 200 | V |
| Gate to source voltage | V _{GSS} | ±20 | V |
| Drain current | ID | 20 | A |
| Drain peak current | I _{D(pulse)} Note1 | 80 | A |
| Body-drain diode reverse drain current | I _{DR} | 20 | A |
| Avalanche current | I _{AP} Note3 | 20 | A |
| Avalanche energy | E _{AR} ^{Note3} | 26 | mJ |
| Channel dissipation | Pch Note2 | 35 | W |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | –55 to +150 | °C |

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at Tc = 25°C

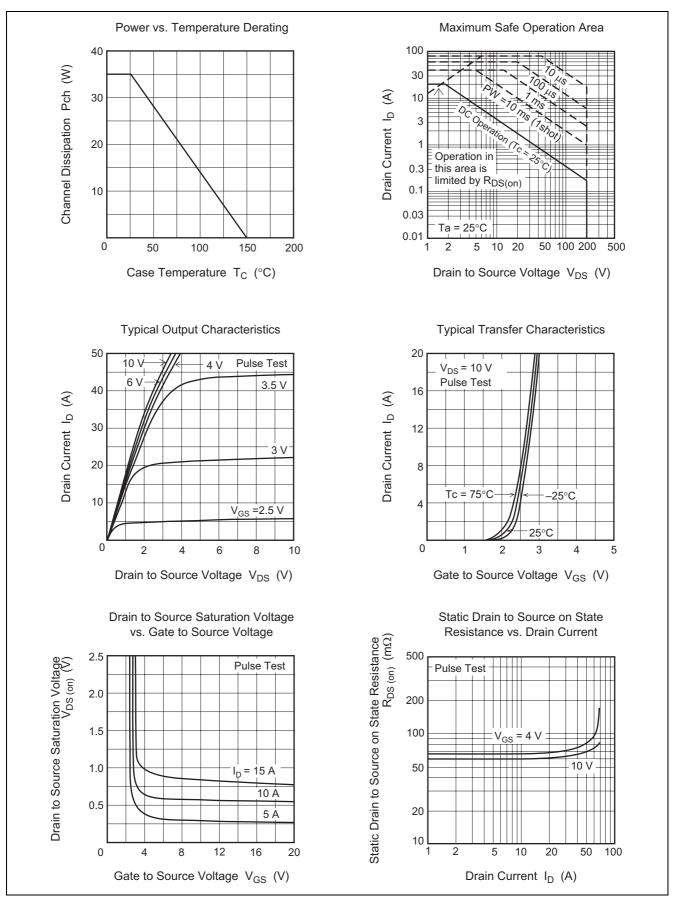
3. Value at Tch = 25°C, Rg \geq 50 Ω

Electrical Characteristics

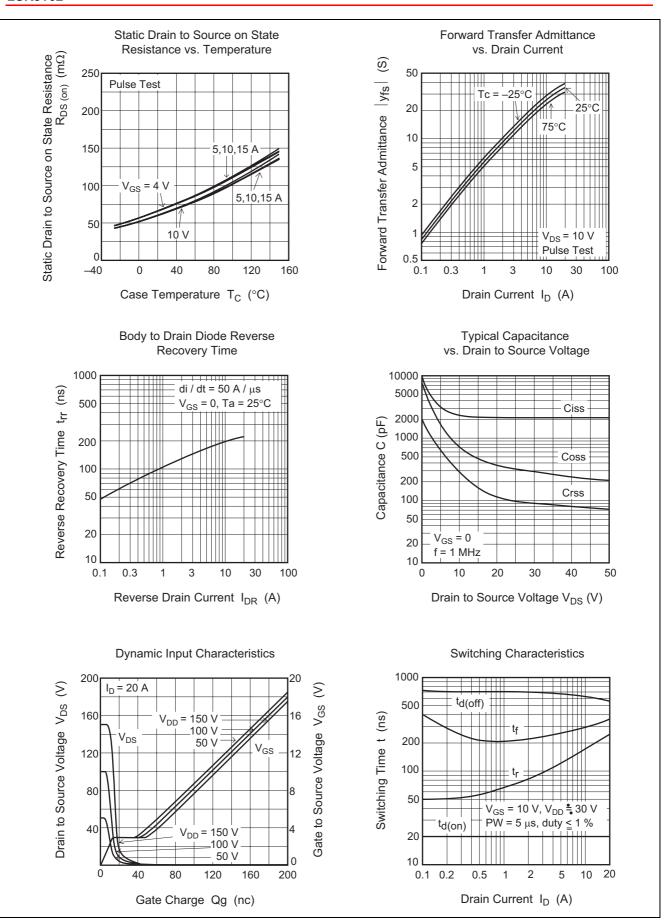
| | | | | | | (Ta = 25°C) |
|-----------------------------------|----------------------|-----|------|-----|------|--|
| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
| Drain to source breakdown voltage | V _{(BR)DSS} | 200 | — | _ | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| Gate to source breakdown voltage | V _{(BR)GSS} | ±20 | — | _ | V | $I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | I _{GSS} | _ | — | ±10 | μΑ | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | _ | — | 10 | μΑ | $V_{DS} = 200 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | V _{GS(off)} | 1.0 | — | 2.5 | V | $I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$ |
| Static drain to source on state | R _{DS(on)} | _ | 60 | 75 | mΩ | $I_D = 10 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$ |
| resistance | R _{DS(on)} | | 65 | 85 | mΩ | $I_D = 10 \text{ A}, V_{GS} = 4 \text{ V}^{Note4}$ |
| Forward transfer admittance | y _{fs} | 15 | 25 | _ | S | $I_D = 10 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$ |
| Input capacitance | Ciss | | 2420 | _ | pF | $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0,$ |
| Output capacitance | Coss | | 790 | _ | pF | f = 1 MHz |
| Reverse transfer capacitance | Crss | | 340 | _ | pF | |
| Turn-on delay time | t _{d(on)} | _ | 20 | _ | ns | $I_D = 10 \text{ A}, V_{GS} = 10 \text{ V},$ $R_L = 3 \Omega$ |
| Rise time | tr | _ | 150 | _ | ns | |
| Turn-off delay time | t _{d(off)} | | 630 | _ | ns | |
| Fall time | t _f | _ | 290 | _ | ns | |
| Body-drain diode forward voltage | V _{DF} | _ | 0.90 | _ | V | $I_F = 20A, V_{GS} = 0$ |
| Body-drain diode reverse recovery | t _{rr} | _ | 210 | _ | ns | $I_F = 20A, V_{GS} = 0$ |
| time | | | | | | di _F / dt = 50 A/ μs |

Note: 4. Pulse test

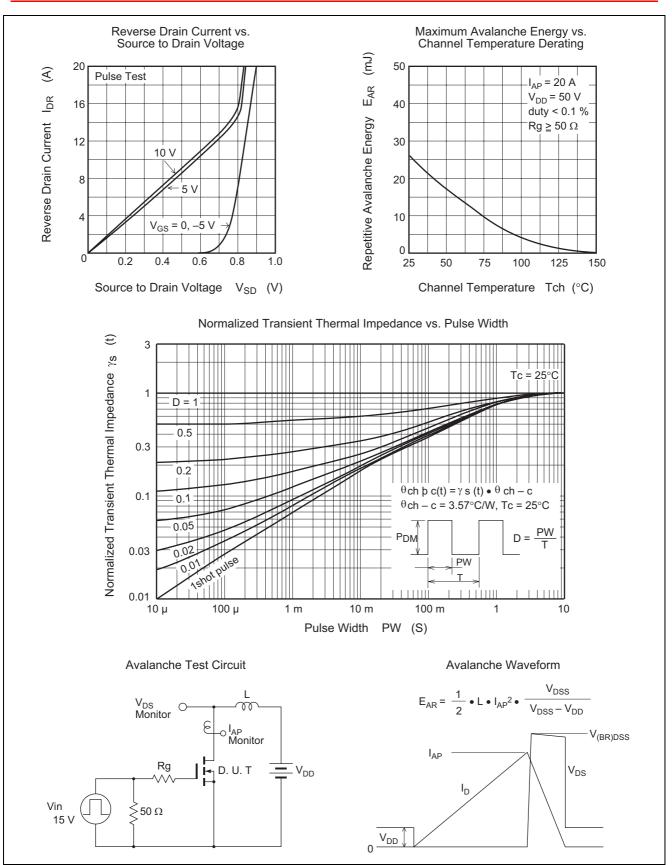
Main Characteristics



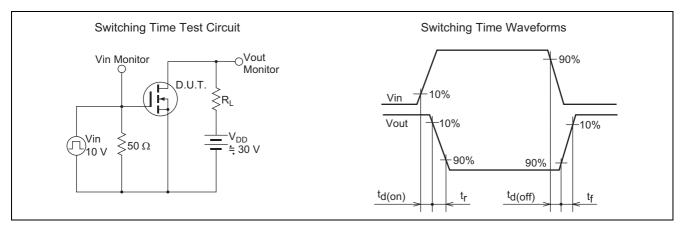






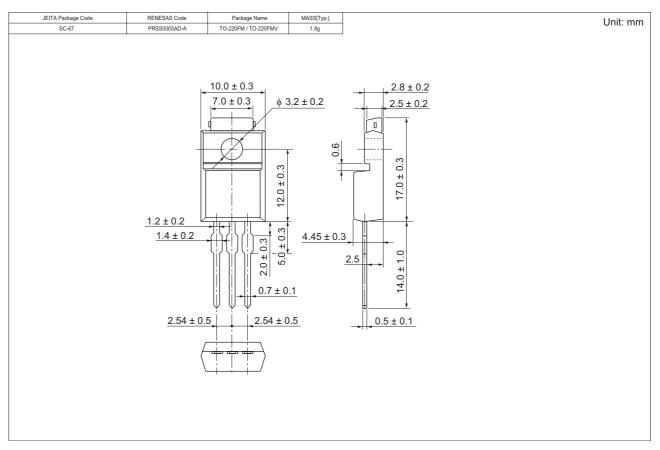








Package Dimensions



Ordering Information

| Part Name | Quantity | Shipping Container |
|-----------|----------|--------------------|
| 2SK3162-E | 500 pcs | Box (Sack) |

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